

L Number	Hits	Search Text	DB	Time stamp
1	5475	(257/\$.ccls. 438/\$.ccls.) and passive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 14:20
2	554	(257/\$.ccls. 438/\$.ccls.) and (chip die IC) and trace\$ and passive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 14:50
3	2	("6040622").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 14:24
4	29	((("6353257") or ("6290481") or ("6462422") or ("6396139") or ("6380059") or ("6462405") or ("6429047") or ("6437447") or ("6458626") or ("6483049") or ("6350669") or ("6281047") or ("6414384") or ("6479894") or ("6459144") or ("6472743") or ("6444498") or ("6291260")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 14:56
5	2	("6040622").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 14:59
6	2313	(257/678-681.ccls. and (encapsul\$4 packag\$4 mold\$4)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 15:01
7	1572	257/678-681.ccls. and (encapsul\$4 packag\$4 mold\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 15:20
8	1162	(257/678-681.ccls. and (encapsul\$4 packag\$4 mold\$4)) and (chip die IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 15:02
9	605	((257/678-681.ccls. and (encapsul\$4 packag\$4 mold\$4)) and (chip die IC)) and (stiffene\$4 fram\$4 ring)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 15:29
10	2037	257/787-796.ccls. and (stiffen\$4 ring fram\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 15:21
11	368	(257/787-796.ccls. and (stiffen\$4 ring fram\$4)) and wiring and (die chip IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 15:22
12	1	("6483030").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:00
13	1511	(257/\$.ccls 438/\$.ccls.) and (stiffen\$4 ring fram\$) with (recess open\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:04

14	945	(257/\$.ccls 438/\$.ccls.) and (stiffen\$4 ring fram\$\$) near5 (recess open\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:08
15	4	257/704-720.ccls. and recess near5 edge and (open\$4 hole) near5 side	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:08
16	73	(257/\$.ccls 438/\$.ccls.) and (stiffen\$4 ring fram\$\$ cap lid (heat adj sink)) near4 (open\$4 hole) near4 side	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:15
17	3069	(fram\$4 (heat adj (sink plate plug element spreader)) stiffen\$4 ring) near5 (hole vias open\$4) with (side adj wall)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:21
18	26	((fram\$4 (heat adj (sink plate plug element spreader)) stiffen\$4 ring) near5 (hole vias open\$4) with (side adj wall)) and 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:23
19	1065	fram\$4 near5 (vias open\$4 hole) near4 (side adj wall)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:31
20	8	(fram\$4 near5 (vias open\$4 hole) near4 (side adj wall)) and (257/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:32
21	2	(ground adj trace) near5 (electrically adj conductive adj adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:37
22	60	("4370528"   "4385209"   "4554400"   "4564722"   "4567317"   "4609104"   "4663565"   "4675139"   "4681712"   "4718215"   "4731286"   "4749972"   "4762966"   "4773091"   "4774914"   "4780570"   "4788381"   "4800464"   "4817337"   "4831210"   "4851609"   "4857668"   "5027426"   "5030118"   "5039825"   "5045636"   "5073761"   "5086226"   "5107404"   "5124889"   "5147121"   "5150282"   "5196814"   "5231967"   "5323299"   "5325021"   "5369701"   "5373555"   "5391083"   "5439021"   "5473117"   "5495399"   "5513071"   "5513078"   "5539149"   "5541610"   "5545843"   "5550713"   "5565656"   "5566055"   "5573000"   "5613221"   "5640457"   "5651701"   "5666095"   "5748254"   "5761042"   "5764492"   "5847938"   "5917708").PN.	USPAT	2002/12/04 16:34
23	3	6157546.URPN.	USPAT	2002/12/04 16:37
24	6	(ground adj trace) with (electrically adj conductive adj adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 17:44
25	0	(cap (heat adj (sink plate element plug spreader)) lid) near5 (step near3 recess\$3) with (top adj side adj edge)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/04 16:44

26	100	(cap (heat adj (sink plate element plug spreader)) lid) near5 (step near3 recess\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/04 16:59
27	2	("5455456"   "5837562").PN.	USPAT	2002/12/04 16:56
28	2	6069027.URPN.	USPAT	2002/12/04 16:57
29	20427	(cap (heat adj (sink plate element plug spreader)) lid) near4 recess\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/04 17:01
30	16345	(cap (heat adj (sink plate element plug spreader)) lid) near3 recess\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/04 17:01
31	4374	(cap (heat adj (sink plate element plug spreader)) lid) near1 recess\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/04 17:02
32	73	(cap (heat adj (sink plate element plug spreader)) lid) near1 recess\$3 near2 edge	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/04 17:05
33	6	(cap (heat adj (sink plate element plug spreader)) lid) near1 recess\$3 near2 (top adj side)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/04 17:06
34	4	(("6232652") or ("6051888")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/04 17:44
35	4	(("5513072") or ("6294831")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/04 17:46
	15	flash adj proof	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/03 14:50
	689	wiring and traces and passive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/03 14:52
	0	257/704-720.ccls. and flash adj proof	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/03 14:52
	19	257/704-720.ccls. and wiring and traces and passive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/03 14:56
	2	257/687-689.ccls. and wiring and traces and passive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/12/03 14:57

-	63	257/687-689.ccls. and trace\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/12/03 19:21
-	702	(257/\$.ccls. 438/\$.ccls.) and encapsulant and (stiffener ring dam)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/12/03 19:31
-	172	(257/\$.ccls. 438/\$.ccls.) and encapsulant and (stiffener ring dam) and trace	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/12/03 19:52
-	6	("5578869"   "5696666"   "5760478"   "5869894"   "5949135"   "5963429").PN.	USPAT	2002/12/03 19:40
-	6	6201302.URPN.	USPAT	2002/12/03 19:41
-	654	(257/\$.ccls. 438/\$.ccls.) and encapsulant and (heat adj (sink plate element plug spreader))	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/12/03 19:54
-	59	(257/\$.ccls. 438/\$.ccls.) and encapsulant with (cover outside encapsulat\$4) with (heat adj (sink plate element plug spreader))	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/12/04 11:32